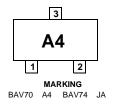


# **BAV70/74**





## **Connection Diagram**



# **Small Signal Diode**

# Absolute Maximum Ratings \* T<sub>A</sub> = 25°C unless otherwise noted

Symbol	Parameter		Value	Units
$V_{RRM}$	Maximum Repetitive Reverse Voltage	BAV70 BAV74	70 50	V V
I <sub>F(AV)</sub>	Average Rectified Forward Current		200	mA
I <sub>FSM</sub>	Non-repetitive Peak Forward Surge Current Pulse Width = 1.0 second Pulse Width = 1.0 microsecond		1.0 2.0	A A
T <sub>STG</sub>	Storage Temperature Range		-55 to +150	°C
T <sub>J</sub>	Operating Junction Temperature		150	°C

<sup>\*</sup> These ratings are limiting values above which the serviceability of the diode may be impaired.

- These ratings are based on a maximum junction temperature of 150 degrees C.
   These are steady limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

## **Thermal Characteristics**

Symbol	Parameter	Value	Units
$P_{D}$	Power Dissipation	350	mW
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	357	°C/W

## Electrical Characteristics T<sub>A</sub>=25°C unless otherwise noted

Symbol	Parameter	•	Test Conditions	Min.	Max.	Units
V <sub>R</sub>	Breakdown Voltage	BAV70 BAV74	$I_R = 100\mu A$ $I_R = 5.0\mu A$	75 50		V V
V <sub>F</sub>	Forward Voltage	BAV70	I <sub>F</sub> = 1.0mA I <sub>F</sub> = 10mA I <sub>F</sub> = 50mA I <sub>F</sub> = 150mA I <sub>F</sub> = 100mA		715 855 1.0 1.25 1.0	mV mV V
I <sub>R</sub>	Reverse Leakage	BAV70 BAV74	$V_R = 25V, T_A = 150^{\circ}C$ $V_R = 70V$ $V_R = 70V, T_A = 150^{\circ}C$ $V_R = 50V, T_A = 150^{\circ}C$ $V_R = 50V, T_A = 150^{\circ}C$		60 5.0 100 100	μΑ μΑ μΑ nA μΑ
СТ	Total Capacitance	BAV70 BAV74	$V_R = 0V, f = 1.0MHz$ $V_R = 0V, f = 1.0MHz$		1.5 2.0	pF pF
t <sub>rr</sub>	Reverse Recovery Time	BAV70 BAV74	$\begin{aligned} &I_F = I_R = 10\text{mA}, \ I_{RR} = 1.0\text{mA}, \\ &R_L = 100\Omega \\ &I_F = I_R = 10\text{mA}, \ I_{RR} = 1.0\text{mA}, \\ &R_L = 100\Omega \end{aligned}$		6.0 4.0	ns ns

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